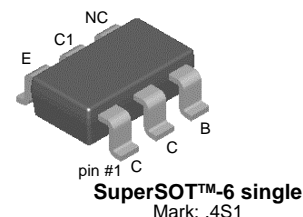


# FMBS5401

## PNP General Purpose Amplifier

- This device is designed as a general purpose amplifier and switch for applications requiring high voltage.



## PNP Epitaxial Silicon Transistor

### Absolute Maximum Ratings\* $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	-150	V
$V_{CBO}$	Collector-Base Voltage	-160	V
$V_{EBO}$	Emitter-Base Voltage	-5.0	V
$I_C$	Collector Current - Continuous	-600	mA
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 ~ 150	$^\circ\text{C}$

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### Notes:

- These ratings are based on a maximum junction temperature of 150 degrees C.
- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Electrical Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
<b>Off Characteristics</b>					
$BV_{CEO}$	Collector-Emitter Breakdown Voltage *	$I_C = -1.0\text{mA}, I_B = 0$	-150		V
$BV_{CBO}$	Collector-Base Breakdown Voltage	$I_C = -100\mu\text{A}, I_E = 0$	-160		V
$BV_{EBO}$	Emitter-Base Breakdown Voltage	$I_E = -10\mu\text{A}, I_C = 0$	-5.0		V
$I_{CBO}$	Collector Cutoff Current	$V_{CB} = -120\text{V}, I_E = 0$ $V_{CB} = -120\text{V}, I_E = 0, T_a = 100^\circ\text{C}$		-50	nA $\mu\text{A}$
$I_{EBO}$	Emitter Cutoff Current	$V_{EB} = -3.0\text{V}, I_C = 0$		-50	nA
<b>On Characteristics *</b>					
$h_{FE}$	DC Current Gain	$I_C = -1.0\text{mA}, V_{CE} = -5.0\text{V}$ $I_C = -10\text{mA}, V_{CE} = -5.0\text{V}$ $I_C = -50\text{mA}, V_{CE} = -5.0\text{V}$	50 60 50	240	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$		-0.2 -0.5	V V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$		-1.0 -1.0	V V
<b>Small Signal Characteristics</b>					
$f_T$	Current Gain Bandwidth Product	$I_C = -10\text{mA}, V_{CE} = -10\text{V},$ $f = 100\text{MHz}$	100	300	MHz
$C_{ob}$	Output Capacitance	$V_{CB} = -10\text{V}, I_E = 0, f = 1\text{MHz}$		6.0	pF
$N_F$	Noise Figure	$I_C = -250\mu\text{A}, V_{CE} = -5.0\text{V}, R_S = 1.0\text{K}\Omega$ $f = 10\text{Hz to } 15.7\text{KHz}$		8.0	dB

\* Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

**Thermal Characteristics**  $T_a=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Max.	Units
$P_D$	Total Device Dissipation *	700	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, total	180	$^\circ\text{C}/\text{W}$

\* Device mounted on a 1 in 2 pad of 2 oz copper

# Typical Characteristics

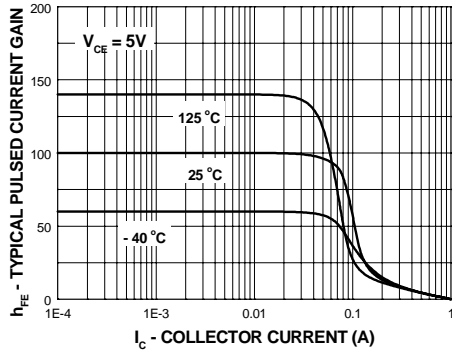


Figure 1. Typical Pulsed Current Gain vs Collector Current

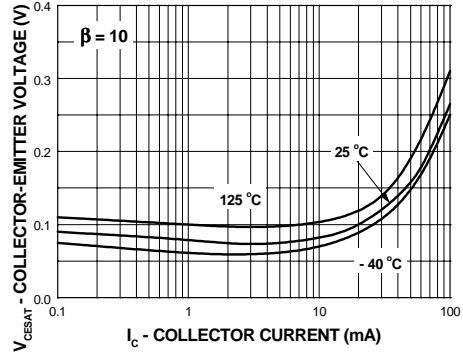


Figure 2. Collector-Emitter Saturation Voltage vs Collector Current

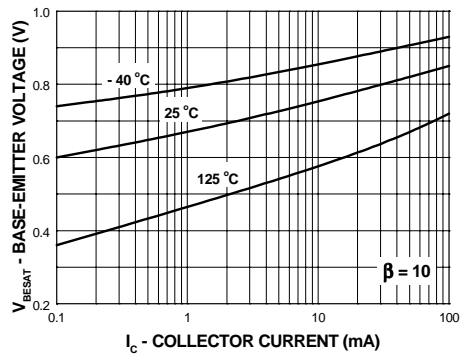


Figure 3. Base-Emitter Saturation Voltage vs Collector Current

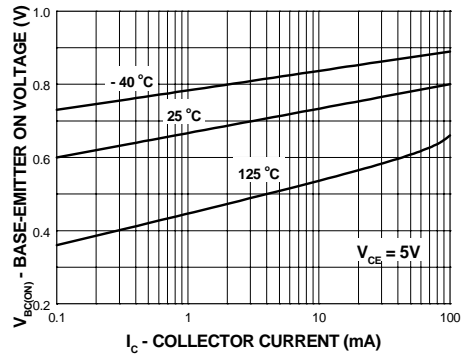


Figure 4. Base-Emitter On Voltage vs Collector Current

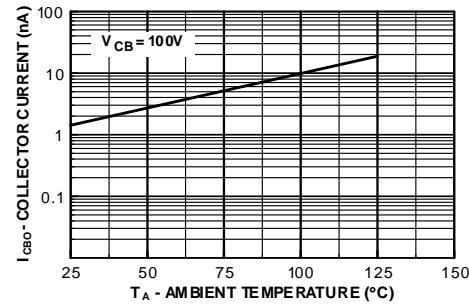


Figure 5. Collector-Cutoff Current vs Ambient Temperature

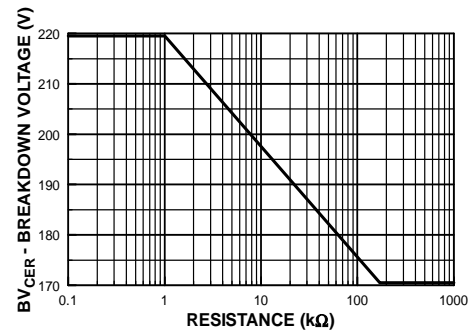


Figure 6. Collector-Emitter Breakdown Voltage with Resistance Between Emitter-Base

### Typical Characteristics (Continued)

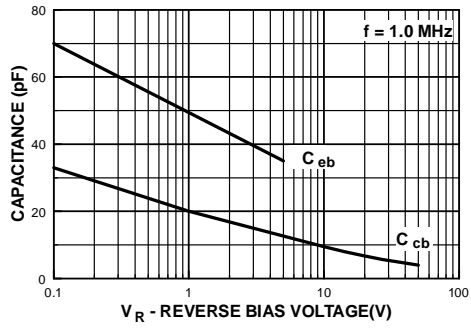
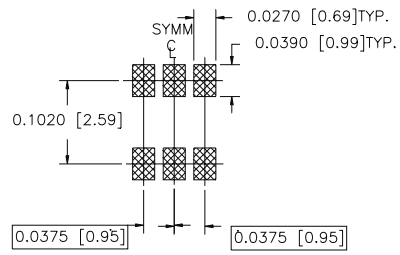
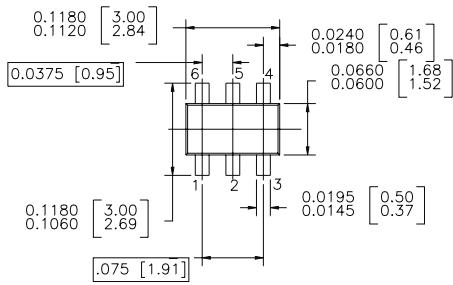


Figure 7. Input and Output Capacitance vs Reverse Voltage

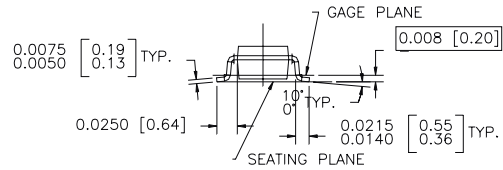
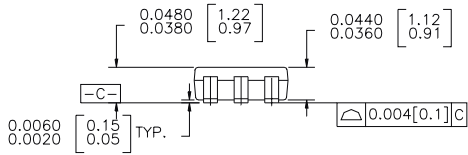
# Package Dimensions

## SuperSOT™-6



LAND PATTERN RECOMMENDATION

CONTROLLING DIMENSION IS INCH  
VALUES IN [ ] ARE MILLIMETERS



SUPER SOT 6 LEADS

- NOTES : UNLESS OTHERWISE SPECIFIED
- 1.0 STANDARD LEAD FINISH : 150 MICROINCHES 93.81 MICROMETERS)  
MINIMUM TIN / LEAD (SOLDER) ON COPPER.
  - 2.0 NO JEDEC REGISTRATION AS OF JULY 1996

Dimensions in Millimeters

## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACE <sub>x</sub> <sup>™</sup>	FAST <sup>®</sup>	ISOPLANAR <sup>™</sup>	Power247 <sup>™</sup>	Stealth <sup>™</sup>
ActiveArray <sup>™</sup>	FAST <sub>r</sub> <sup>™</sup>	LittleFET <sup>™</sup>	PowerEdge <sup>™</sup>	SuperFET <sup>™</sup>
Bottomless <sup>™</sup>	FPS <sup>™</sup>	MICROCOUPLER <sup>™</sup>	PowerSaver <sup>™</sup>	SuperSOT <sup>™</sup> -3
CoolFET <sup>™</sup>	FRFET <sup>™</sup>	MicroFET <sup>™</sup>	PowerTrench <sup>®</sup>	SuperSOT <sup>™</sup> -6
CROSSVOLT <sup>™</sup>	GlobalOptoisolator <sup>™</sup>	MicroPak <sup>™</sup>	QFET <sup>®</sup>	SuperSOT <sup>™</sup> -8
DO <sub>M</sub> E <sup>™</sup>	GTO <sup>™</sup>	MICROWIRE <sup>™</sup>	Q <sub>S</sub> <sup>™</sup>	SyncFET <sup>™</sup>
EcoSPARK <sup>™</sup>	HiSeC <sup>™</sup>	MSX <sup>™</sup>	QT Optoelectronics <sup>™</sup>	TinyLogic <sup>®</sup>
E <sup>2</sup> CMOS <sup>™</sup>	I <sup>2</sup> C <sup>™</sup>	MSXPro <sup>™</sup>	Quiet Series <sup>™</sup>	TINYOPTO <sup>™</sup>
EnSigna <sup>™</sup>	<i>i-Lo</i> <sup>™</sup>	OCX <sup>™</sup>	RapidConfigure <sup>™</sup>	TruTranslation <sup>™</sup>
FACT <sup>™</sup>	ImpliedDisconnect <sup>™</sup>	OCXPro <sup>™</sup>	RapidConnect <sup>™</sup>	UHC <sup>™</sup>
FACT Quiet Series <sup>™</sup>		OPTOLOGIC <sup>®</sup>	μSerDes <sup>™</sup>	UltraFET <sup>®</sup>
Across the board. Around the world. <sup>™</sup>		OPTOPLANAR <sup>™</sup>	SILENT SWITCHER <sup>®</sup>	VCX <sup>™</sup>
The Power Franchise <sup>®</sup>		PACMAN <sup>™</sup>	SMART START <sup>™</sup>	
Programmable Active Droop <sup>™</sup>		POP <sup>™</sup>	SPM <sup>™</sup>	

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.